

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74VHC4040F, TC74VHC4040FK**

### 12-Stage Ripple Carry Binary Counter

The TC74VHC4040 is an advanced high speed CMOS 12-STAGE BINARY COUNTER/DIVIDER fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Setting CLR to high resets the counter to low.

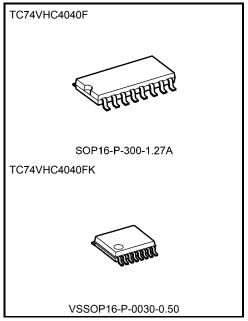
A negative transition on the  $\overline{\mbox{CK}}$  input brings one increment into the counter.

This counter provides all divided output stages, and at Q12, a 1/4096 divided frequency will be output.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

- High speed: fmax = 210 MHz (typ.) at VCC = 5 V
- Low power dissipation: ICC = 4 μA (max) at Ta = 25°C
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: tpLH ≃ tpHL
- Wide operating voltage range: VCC (opr) = 2 V to 5.5 V
- Low noise: VOLP = 1.5 V (max)
- Pin and function compatible with 74HC4040



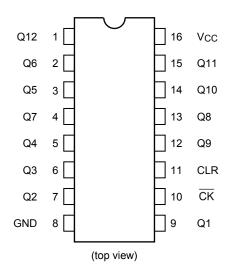
Weight

SOP16-P-300-1.27A : 0.18 g (typ.) VSSOP16-P-0030-0.50 : 0.02 g (typ.)

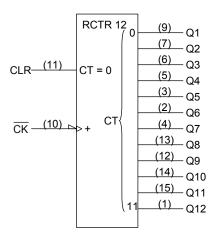
Start of commercial production 1992-05



# **Pin Assignment**



# **IEC Logic Symbol**



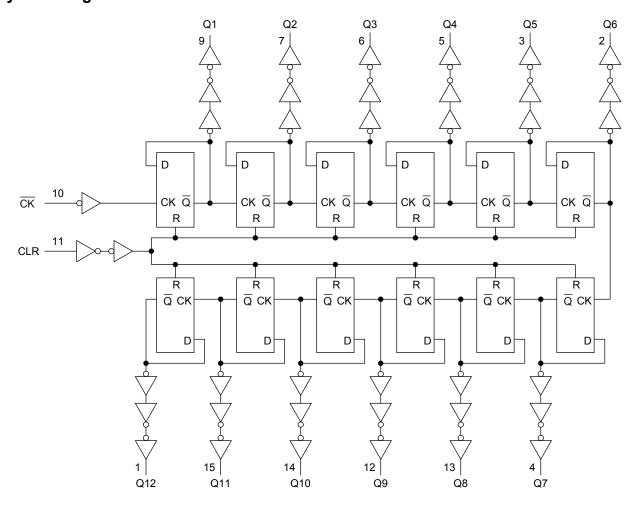
# **Truth Table**

СК	CLR	Output State
Х	Н	All Outputs = "L"
	L	No Change
$\overline{}$	L	Advance to Next State

X: Don't care



### **System Diagram**



### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to 7.0	V
DC output voltage	Vout	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	lıĸ	-20	mA
Output diode current	Іок	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±100	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2.0 to 5.5	V
Input voltage	VIN	0 to 5.5	V
Output voltage	Vout	0 to Vcc	V
Operating temperature	Topr	−40 to 85	°C
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V) 0 to 20 (V <sub>CC</sub> = 5 ± 0.5 V)	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Te Symbol		Test Condition	Γest Condition		Ta = 25°C			Ta = −40 to 85°C	
		,		Vcc (V)	Min	Тур.	Max	Min	Max	
High-level input voltage	ViH	_		2.0 3.0 to 5.5	1.50 VCC × 0.7	1 1		1.50 V <sub>CC</sub> × 0.7		٧
Low-level input voltage	V <sub>IL</sub>	_		2.0 3.0 to 5.5	_ _		0.50 VCC × 0.3	_ _	0.50 VCC × 0.3	٧
High-level output voltage	gh-level output VoH VIN = VIH o	VIN = VIH or VIL	I <sub>OH</sub> = -50 μA	2.0 3.0 4.5	1.9 2.9 4.4 2.58	2.0 3.0 4.5	_ _ _	1.9 2.9 4.4 2.48	_ _ _	>
			I <sub>OH</sub> = -8 mA	4.5	3.94	_	_	3.80	_	
Low-level output voltage VOL	Vol	VIN = VIH or VIL	I <sub>OL</sub> = 50 μA	2.0 3.0 4.5	_ _ _	0.0 0.0 0.0	0.1 0.1 0.1	_ _ _	0.1 0.1 0.1	V
			I <sub>OL</sub> = 4 mA I <sub>OL</sub> = 8 mA	3.0 4.5	_		0.36 0.36	_	0.44 0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5		_	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	4.0	_	40.0	μΑ



### Timing Requirements (input: tr = tf = 3 ns)

Characteristics	Symbol	Test Condition	Ta = 25°C		Ta = -40 to 85°C	Unit	
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width ( CK )	tw (L) tw (H)	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$		5.0 5.0	5.0 5.0	ns
Minimum pulse width (CLR)	tw (H)	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$	_ _	5.0 5.0	5.0 5.0	ns
Minimum removal time	t <sub>rem</sub>	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$		5.0 5.0	5.0 5.0	ns

### AC Characteristics (input: tr = tf = 3 ns)

Characteristics	Te Symbol		st Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
	- J		Vcc (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	J
			3.3 ± 0.3	15	_	7.5	11.9	1.0	14.0	
Propagation delay time	t <sub>pLH</sub>			50	_	10.0	15.4	1.0	17.5	
( <del>CK</del> -Q1)	t <sub>pHL</sub>	_	5.0 ± 0.5	15	_	4.8	7.3	1.0	8.5	ns
			5.0 ± 0.5	50	_	6.3	9.3	1.0	10.5	
Propagation delay			$3.3 \pm 0.3$	50	_	2.4	4.4	_	5.0	
time $(Q_n-Q_n + 1)$	$\Delta t_{pd}$	_	5.0 ± 0.5	50	_	1.6	3.1	_	3.5	ns
Propagation delay		t <sub>рН</sub>	3.3 ± 0.3	15	_	8.3	12.8	1.0	15.0	ns ns
				50	_	10.8	16.3	1.0	18.5	
(CLR-Q)	ŀрНL		5.0 ± 0.5	15	_	5.6	8.6	1.0	10.0	
( = ==,				50	_	7.1	10.6	1.0	12.0	
	f <sub>max</sub>		3.3 ± 0.3	15	75	140	_	75	_	- MHz
Maximum clock				50	55	80	_	50	_	
frequency		_	50.05	15	150	210	_	125	_	
			5.0 ± 0.5	50	95	125	_	80	_	
Input capacitance	CIN		_		_	4	10	_	10	pF
Power dissipation capacitance	CPD			(Note)	_	21	_	_	_	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

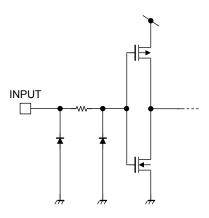
 $ICC (opr) = CPD \cdot VCC \cdot fIN + ICC$ 



# Noise Characteristics (input: tr = tf = 3 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C		Unit
	,		Vcc (V)	Тур.	Limit	
Quiet output maximum dynamic V <sub>OL</sub>	VOLP	C <sub>L</sub> = 50 pF	5.0	1.2	1.5	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-1.2	-1.5	V
Minimum high level dynamic input voltage	VIHD	C <sub>L</sub> = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage	VILD	C <sub>L</sub> = 50 pF	5.0	_	1.5	V

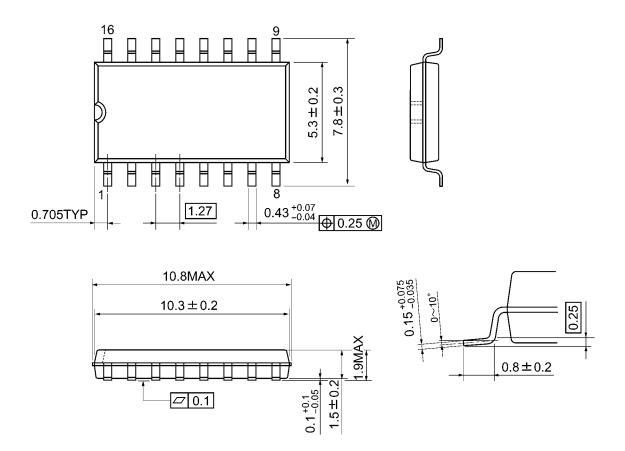
# **Input Equivalent Circuit**





# **Package Dimensions**

SOP16-P-300-1.27A Unit: mm

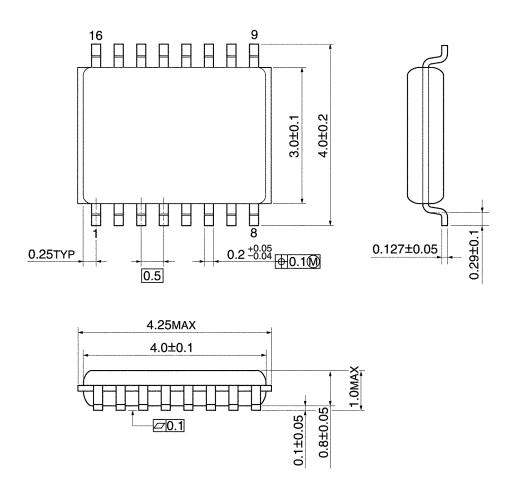


Weight: 0.18 g (typ.)



# **Package Dimensions**

VSSOP16-P-0030-0.50 Unit: mm



8

Weight: 0.02 g (typ.)



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